**Product data sheet** 

## 1. General description

Planar passivated Silicon Controlled Rectifier (SCR) module in WeEnPACK-20mm (TO-240AA) for use in applications requiring high blocking voltage capability, high inrush current capability and high thermal cycling performance

#### 2. Features and benefits

- High blocking voltage capability
- High thermal cycling performance
- Planar passivated for voltage ruggedness and reliability
- Package meets UL certification
- Package is RoHS compliant
- · Industry standard outline
- Soldering pins for PCB mounting
- Copper base plate
- · Cathode Kelvin contacts provided
- UL1557 certified (Document number E346397)

### 3. Applications

- Softstart AC motor control
- DC Motor control
- AC power control
- Power converter
- Temperature control
- Lighting control

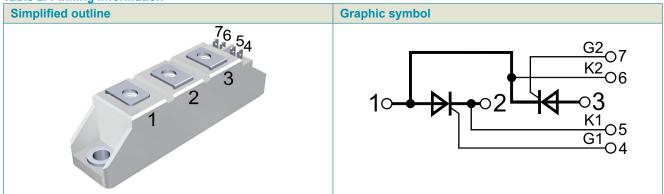
#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit
Absolute	maximum rating						
$V_{DRM}$	repetitive peak forward voltage				1600		V
$V_{RRM}$	repetitive peak reverse voltage				1600		V
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave			63		А
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 10 \text{ ms}$		750			Α
		half sine wave; $T_{j(init)} = 130  ^{\circ}\text{C}$ ; $t_p = 10  \text{ms}$			650		Α
		half sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 8.3 \text{ ms}$			825		Α
		half sine wave; $T_{j(init)} = 130  ^{\circ}\text{C}$ ; $t_p = 8.3  \text{ms}$			660		Α
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C		30	-	80	mA
$V_{GT}$	gate trigger voltage	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C		-	0.85	1.20	V
V <sub>T</sub>	on-state voltage	I <sub>τ</sub> = 40 A; T <sub>j</sub> = 25 °C		-	1.15	1.25	V

# 5. Pinning information

Table 2. Pinning information



## 6. Ordering information

**Table 3. Ordering information** 

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WTMH40T16R	WeEnPACK-20mm	WTMH40T16RT	Tray	12	WeEnPACK- 20mmPHB-C	26-Jun-2023

## 7. Marking

**Table 4. Marking codes** 

Type number	Marking codes
WTMH40T16R	WTMH40T16R

# 8. Limiting values

**Table 5. Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{DRM}$	repetitive peak forward voltage			1600	V
$V_{RRM}$	repetitive peak reverse voltage			1600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave		40	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave		63	Α
I <sub>TSM</sub>	non-repetitive peak onstate	half sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 10 \text{ ms}$		750	Α
	current	half sine wave; $T_{j(init)} = 130  ^{\circ}\text{C}$ ; $t_p = 10  \text{ms}$		650	Α
		half sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 8.3 \text{ ms}$		825	Α
		half sine wave; $T_{j(init)}$ = 130 °C; $t_p$ = 8.3 ms		660	Α
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine-wave pulse		2.8	kA²s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 200 mA; T <sub>j</sub> = 130 °C		150	A/µs
I <sub>GM</sub>	peak gate current			10	А
$V_{RGM}$	peak reverse gate voltage			5	V
$P_{GM}$	peak gate power			20	W
$P_{G(AV)}$	average gate power	over any 20 ms period		0.5	W
T <sub>stg</sub>	storage temperature			-40 to 130	°C
T <sub>j</sub>	junction temperature			-40 to 150	°C

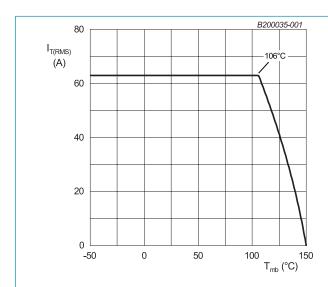
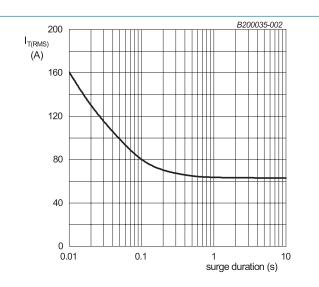


Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values



 $f = 50 \text{ Hz}; T_{mb} = 106 \text{ }^{\circ}\text{C}$ 

Fig. 2. RMS on-state current as a function of surge duration; maximum values

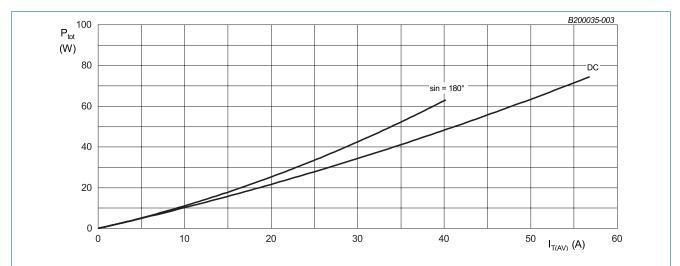
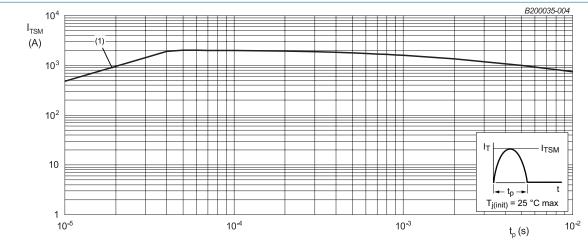


Fig. 3. Total power dissipation as a function of average on-state current; maximum values; per thyristor



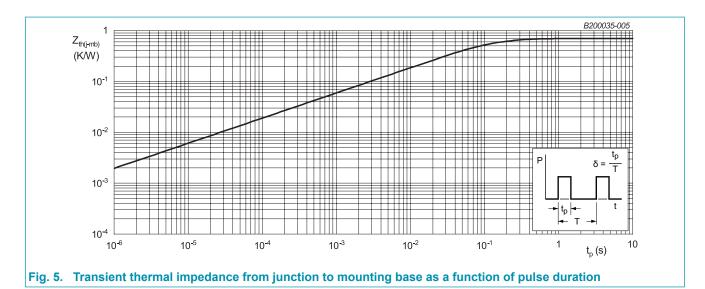
 $t_p \le 10 \text{ ms}$ (1)  $dI_T/dt \text{ limit}$ 

Fig. 4. Non-repetitive peak on-state current as a function of pulse width; maximum values

### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
u1(J-C)	thermal resistance from junction to case	per thyristor	-	-	0.70	K/W
		per module	-	-	0.40	K/W
R <sub>th(j-h)</sub>	thermal resistance from junction to heatsink	per thyristor	-	-	0.90	K/W
		per module	-	-	0.55	K/W



# 10. Package characteristics

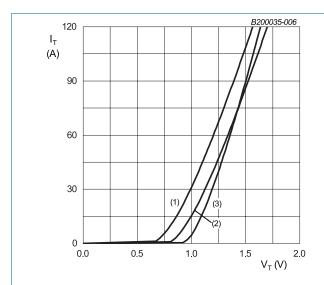
**Table 7. Isolation characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>isol</sub>	isolation voltage	50/60 Hz; RMS; $I_{ISOL} \le 1$ mA; t = 1 second; AC	-	-	3600	V
		50/60 Hz; RMS; I <sub>ISOL</sub> ≤ 1 mA; t = 1 minute; AC	-	-	3000	V

## 11. Characteristics

#### **Table 8. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}$	30	-	80	mA
$V_{GT}$	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}$	-	0.85	1.20	V
		$V_D = 2/3 V_{DRM}$ ; $I_T = 0.1 A$ ; $T_j = 130 °C$	0.25	0.4	-	V
I <sub>GD</sub>	gate non-trigger current	T <sub>j</sub> = 130 °C	-	-	7	mA
$V_{GD}$	gate non-trigger voltage	T <sub>j</sub> = 130 °C	-	-	0.17	V
I <sub>L</sub>	latching current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}$	-	-	300	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C	-	-	200	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 40 A; T <sub>j</sub> = 25 °C	-	1.15	1.25	V
		I <sub>T</sub> = 80 A; T <sub>j</sub> = 25 °C	-	-	1.60	V
V <sub>TO</sub>	threshold voltage	T <sub>j</sub> = 130 °C	-	-	0.96	V
r <sub>T</sub>	slope resistance	T <sub>j</sub> = 130 °C	-	-	6.2	mΩ
I <sub>D</sub>	off-state current	V <sub>D</sub> = 1600 V; T <sub>j</sub> = 25 °C	-	-	50	μA
		V <sub>D</sub> = 1600 V; T <sub>j</sub> = 150 °C	-	-	10	mA
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1600 V; T <sub>j</sub> = 25 °C	-	-	50	μA
		V <sub>R</sub> = 1600 V; T <sub>j</sub> = 150 °C	-	-	10	mA
Dynamic	characteristics		'			
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 1072 V; $T_j$ = 130 °C; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; gate open circuit	1500	-	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ $(dI_G/dt)_M = 1 \text{ A}/\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$I_{TM}$ = 2 A; $t_p$ = 50 µs; dV/dt = 5 V/µs; dI/dt = 30 A/µs; $T_i$ = 25 °C	-	150	-	μs



 $V_{TO}$  = 0.96 V;  $r_{T}$  = 0.0062  $\Omega$ 

(1) T<sub>j</sub> = 130 °C; typical values (2) T<sub>j</sub> = 130 °C; maximum values

(3) T<sub>i</sub> = 25 °C; maximum values

Fig. 6. On-state current as a function of on-state voltage

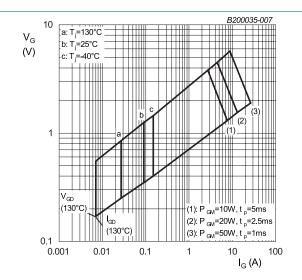
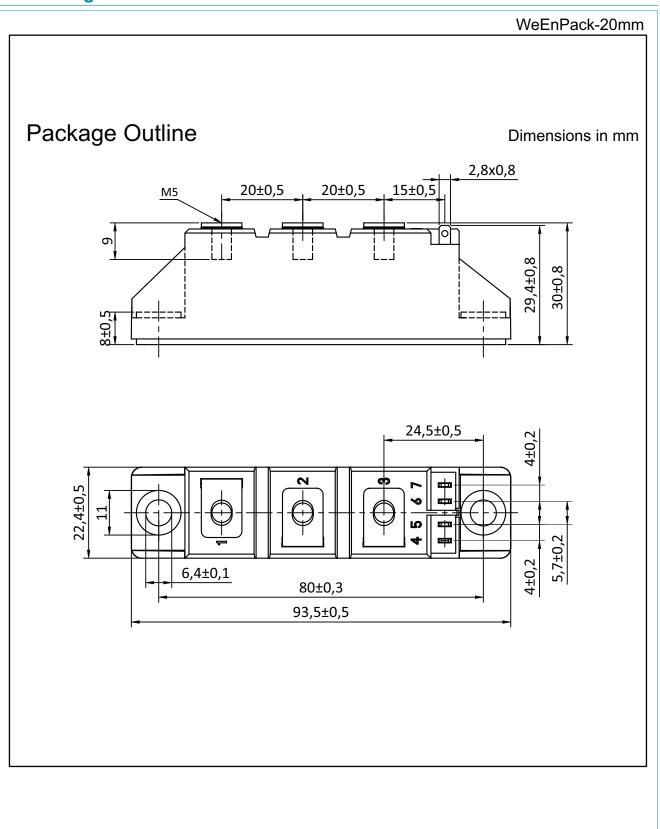


Fig. 7. Gate voltage as a function of gate current

# 12. Package outline



#### 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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**WTMH40T16R** 

**SCR Module** 

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